Preferred Device

## **Sensitive Gate Silicon Controlled Rectifiers**

## **Reverse Blocking Thyristors**

Annular PNPN devices designed for high volume consumer applications such as relay and lamp drivers, small motor controls, gate drivers for larger thyristors, and sensing and detection circuits. Supplied in an inexpensive plastic TO-92/TO-226AA package which is readily adaptable for use in automatic insertion equipment.

#### **Features**

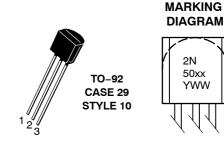
- Sensitive Gate Trigger Current 200 μA Maximum
- Low Reverse and Forward Blocking Current 50  $\mu A$  Maximum,  $T_C$  = 110°C
- Low Holding Current 5 mA Maximum
- Passivated Surface for Reliability and Uniformity
- Device Marking: Device Type, e.g., 2N5060, Date Code
- Pb-Free Packages are Available\*



ON Semiconductor®

# RECTIFIERS 0.8 A RMS, 30 – 200 V





50xx Specific Device Code Y = Year

WW = Work Week

PIN ASSIGNMENT		
1	Cathode	
2	Gate	
3	3 Anode	

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

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<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage (Note 1) $ (T_J = -40 \text{ to } 110^{\circ}\text{C}, \text{ Sine Wave}, \\ 50 \text{ to } 60 \text{ Hz}, R_{GK} = 1 \text{ k}\Omega) & 2\text{N}5060 \\ & 2\text{N}5061 \\ & 2\text{N}5062 \\ & 2\text{N}5064 $	V <sub>DRM</sub> , V <sub>RRM</sub>	30 60 100 200	V
On-State Current RMS (180° Conduction Angles; T <sub>C</sub> = 80°C)	I <sub>T(RMS)</sub>	0.8	А
*Average On-State Current (180 $^{\circ}$ Conduction Angles) ( $T_{C}$ = 67 $^{\circ}$ C) ( $T_{C}$ = 102 $^{\circ}$ C)	I <sub>T(AV)</sub>	0.51 0.255	A
*Peak Non-repetitive Surge Current, T <sub>A</sub> = 25°C (1/2 cycle, Sine Wave, 60 Hz)	I <sub>TSM</sub>	10	А
Circuit Fusing Considerations (t = 8.3 ms)	l <sup>2</sup> t	0.4	A <sup>2</sup> s
*Average On-State Current (180° Conduction Angles) (T <sub>C</sub> = 67°C) (T <sub>C</sub> = 102°C)	I <sub>T(AV)</sub>	0.51 0.255	A
*Forward Peak Gate Power (Pulse Width $\leq 1.0 \mu sec; T_A = 25^{\circ}C)$	P <sub>GM</sub>	0.1	W
*Forward Average Gate Power (T <sub>A</sub> = 25°C, t = 8.3 ms)	P <sub>G(AV)</sub>	0.01	W
*Forward Peak Gate Current (Pulse Width ≤ 1.0 µsec; T <sub>A</sub> = 25°C)	I <sub>GM</sub>	1.0	Α
*Reverse Peak Gate Voltage (Pulse Width $\leq 1.0 \mu sec; T_A = 25^{\circ}C$ )	$V_{RGM}$	5.0	V
*Operating Junction Temperature Range	TJ	-40 to +110	°C
*Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### THERMAL CHARACTERISTICS

Characteristic		Max	Unit
*Thermal Resistance, Junction-to-Case (Note 2)	$R_{ heta JC}$	75	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	200	°C/W

<sup>2.</sup> This measurement is made with the case mounted "flat side down" on a heatsink and held in position by means of a metal clamp over the curved surface.

V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

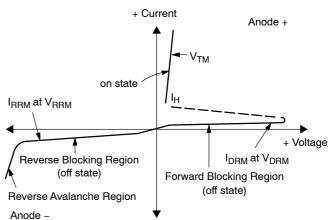
<sup>\*</sup>Indicates JEDEC Registered Data.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		•				
*Peak Repetitive Forward or Reverse Blocking Curr ( $V_{AK}$ = Rated $V_{DRM}$ or $V_{RRM}$ )	ent (Note 3) T <sub>C</sub> = 25°C T <sub>C</sub> = 110°C	I <sub>DRM</sub> , I <sub>RRM</sub>	_ _	- -	10 50	μ <b>Α</b> μ <b>Α</b>
ON CHARACTERISTICS			•	•		•
*Peak Forward On-State Voltage (Note 4) (I <sub>TM</sub> = 1.2 A peak @ T <sub>A</sub> = 25°C)		V <sub>TM</sub>	-	-	1.7	V
Gate Trigger Current (Continuous DC) (Note 5) $*(V_{AK} = 7.0 \text{ Vdc}, R_L = 100 \Omega)$	T <sub>C</sub> = 25°C T <sub>C</sub> = -40°C	I <sub>GT</sub>	- -	- -	200 350	μΑ
Gate Trigger Voltage (Continuous DC) (Note 5) *(V <sub>AK</sub> = 7.0 Vdc, R <sub>L</sub> = 100 $\Omega$ )	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	V <sub>GT</sub>	-	- -	0.8 1.2	V
*Gate Non-Trigger Voltage $(V_{AK} = Rated \ V_{DRM}, \ R_L = 100 \ \Omega) \ T_C = 110^{\circ}C$		V <sub>GD</sub>	0.1	-	-	V
Holding Current (Note 3)  *(V <sub>AK</sub> = 7.0 Vdc, initiating current = 20 mA)	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	lн	- -	- -	5.0 10	mA
Turn-On Time Delay Time Rise Time $(I_{GT} = 1.0 \text{ mA}, V_D = \text{Rated } V_{DRM},$ Forward Current = 1.0 A, di/dt = 6.0 A/ $\mu$ s		t <sub>d</sub> t <sub>r</sub>	-	3.0 0.2	- -	μs
Turn-Off Time (Forward Current = 1.0 A pulse, Pulse Width = 50 $\mu$ s, 0.1% Duty Cycle, di/dt = 6.0 A/ $\mu$ s, dv/dt = 20 V/ $\mu$ s, I <sub>GT</sub> = 1 mA) 2N5060, 2 2N5062, 2		tq	_ _	10 30		μs
DYNAMIC CHARACTERISTICS						
Critical Rate of Rise of Off–State Voltage (Rated $V_{DRM}$ , Exponential, $R_{GK}$ = 1 k $\Omega$ )		dv/dt	_	30	_	V/μs

#### **Voltage Current Characteristic of SCR**

Symbol	Parameter
$V_{DRM}$	Peak Repetitive Off State Forward Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Off State Reverse Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Peak on State Voltage
I <sub>H</sub>	Holding Current



<sup>3.</sup>  $R_{GK} = 1000 \,\Omega$  is included in measurement.
4. Forward current applied for 1 ms maximum duration, duty cycle  $\leq$  1%.
5.  $R_{GK}$  current is not included in measurement.
\*Indicates JEDEC Registered Data.

#### **ORDERING INFORMATION**

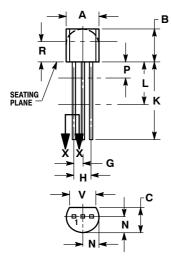
Device	Package	Shipping <sup>†</sup>
2N5060	TO-92	5,000 Units / Box
2N5060G	TO-92 (Pb-Free)	5,000 Units / Box
2N5060RLRA	TO-92	2,000 / Tape & Reel
2N5060RLRAG	TO-92 (Pb-Free)	2,000 / Tape & Reel
2N5060RLRM	TO-92	2,000 / Ammo Pack
2N5060RLRMG	TO-92 (Pb-Free)	2000 / Ammo Pack
2N5061	TO-92	5,000 Units / Box
2N5061G	TO-92 (Pb-Free)	5,000 Units / Box
2N5061RLRA	TO-92	2,000 / Tape & Reel
2N5061RLRAG	TO-92 (Pb-Free)	2,000 / Tape & Reel
2N5062	TO-92	5,000 Units / Box
2N5062G	TO-92 (Pb-Free)	5,000 Units / Box
2N5062RLRA	TO-92	2,000 / Tape & Reel
2N5062RLRAG	TO-92 (Pb-Free)	2,000 / Tape & Reel
2N5064	TO-92	5,000 Units / Box
2N5064RLRA	TO-92	2,000 / Tape & Reel
2N5064RLRM	TO-92	2,000 / Ammo Pack
2N5064RLRMG	TO-92 (Pb-Free)	2,000 / Ammo Pack
2N5064RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
2N5064G	TO-92 (Pb-Free)	5000 Units / Box

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **PACKAGE DIMENSIONS**

#### TO-92 (TO-226) CASE 29-11

**ISSUE AM** 

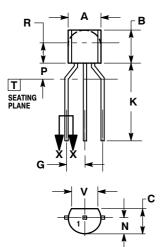


STRAIGHT LEAD **BULK PACK** 



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
  4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
۲	0.015	0.020	0.39	0.50
K	0.500		12.70	
٦	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	



**BENT LEAD** TAPE & REEL AMMO PACK



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
  4. LEAD DIMENSION IS UNCONTROLLED IN PAND BEYOND DIMENSION K MINIMUM.

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.45	5.20	
В	4.32	5.33	
С	3.18	4.19	
D	0.40	0.54	
G	2.40	2.80	
J	0.39	0.50	
K	12.70		
N	2.04	2.66	
Р	1.50	4.00	
R	2.93		
٧	3.43		

#### STYLE 10:

- PIN 1. CATHODE 2. GATE 3. ANODE